Large anomalous Nernst effect in the ferromagnetic Fe₃Si polycrystal

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Abstract

The high-throughput calculation predicts that the Fe-based cubic ferromagnet Fe₃Si may exhibit a large anomalous Nernst effect (ANE). Here, we report our experimental observation of the large Nernst coefficient $S_{yx} \sim 2 \mu V/K$ and the transverse thermoelectric coefficient $-\alpha_{yx} \sim 3 \text{ Am}^{-1}\text{K}^{-1}$ for Fe₃Si polycrystal at room temperature. The large $-\alpha_{yx}$ indicates that the large ANE originates from the intrinsic Berry curvature mechanism. The high Curie temperature of 840 K and the most abundant raw elements of Fe and Si make Fe₃Si a competitive candidate for Nernst thermoelectric generations.

Keywords: Anomalous Nernst effect, Thermoelectrics, Ferromagnet, Polycrystal

I. INTRODUCTION

The thermoelectric (TE) effect, converting the heat current into electric energy directly, has a great potential for energy harvesting and heat flow sensors for advanced Internet of Things (IoT) society [1–3]. Ferromagnets can induce transverse thermoelectric voltages, so-called anomalous Nernst effect (ANE), which appears perpendicular to heat flow and magnetization. Recently, the ANE has attracted wide attention owing to its unique advantages for large-area and flexible thermoelectric devices [4, 5]. Thanks to recent developments in topological physics, giant ANE and anomalous Hall effect (AHE) enhanced by the large Berry curvature have been discovered in various ferromagnets and even antiferromagnets [6–10]. One of the most attractive candidates is Fe₃X (X = Ga, Al) where the Nernst coefficient S_{yx} reaches up to 6 and 4 μ V/K at room temperature in Fe₃Ga and Fe₃Al, respectively [7]. The theoretical analysis indicates that such a giant ANE originated from the topological nodal web structure around the Fermi energy E_F .

Here, we focus on a sister compound, cubic $D0_3$ Fe₃Si (Fig.1(a)) [11]. The large ANE in Fe₃Si is predicted by the high throughput calculation [7]. The Curie temperature (T_C) of Fe₃Si ~ 840 K is higher than that for Fe₃Ga (720 K) and Fe₃Al (600 K) [12–14], which is beneficial for TE application at high temperature. Besides, silicon is the most abundant element in the earth's crust and widely used for industry. However, the experimental report of ANE for Fe₃Si is limited only for thin films and its value is small $|S_{yx}| < \sim 1 \,\mu\text{V/K}$ [15].

In this paper, we report the temperature (T) and magnetic field (B) dependence of the electric and thermoelectric properties for the bulk polycrystalline Fe₃Si. We find a large room-temperature

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Nernst coefficient $S_{yx} \sim 2 \ \mu V/K$, which is twice larger than the previous report using thin films [15]. We also estimate the transverse thermoelectric coefficient $|\alpha_{yx}|$ and found a large room-temperature value $\sim 3 \text{ Am}^{-1}\text{K}^{-1}$, suggesting the dominant intrinsic contribution. The analysis of the band structure indicates dispersion-less flat bands on the Γ -X line might have significant contribution to the large ANE response.

II. EXPERIMENTS AND DISCUSSION

Polycrystalline Fe₃Si samples were synthesized by the melt cooling method in a mono-arc furnace. As-grown samples were used for all characterization and measurements. The powder X-ray diffraction (XRD) result shows the single phase of the $D0_3$ Fe₃Si with a lattice constant of 5.65 Å. The scanning Electron Microscope-Energy Dispersive X-ray Spectrometry (SEM-EDX) method shows our Fe₃Si is stoichiometric within a few percent resolutions. The bar-shaped samples were used for all the transport properties, including Hall and longitudinal resistivity (ρ_{yx} and ρ_{xx}), Nernst and Seebeck coefficients (S_{yx} and S_{xx}) in a physical properties measurement system (PPMS, Quantum Design) with a thermal transport option (TTO). To remove the longitudinal contributions, ρ_{xx} and S_{xx} , the temperature dependence of ρ_{yx} and S_{xx} were evaluated by symmetrization of the data with the positive and negative field sweeps. Magnetization was measured by a commercial magnetic properties measurement system (MPMS, Quantum Design) with the needle-like sample (~ 0.2 mg). For all measurements, no specific orientation was chosen since the poly-crystalline nature could guarantee isotropic transport properties.

The electronic structure of Fe₃Si was obtained by using the OpenMX code [16], where the exchange-correlation functional within the generalized gradient approximation and normconserving pseudopotentials were employed [17]. The spin-orbit coupling was induced by using total angular momentum-dependent pseudopotentials. The wave functions were expanded by a linear combination of multiple pseudoatomic orbitals [18]. A set of pseudoatomic orbital basis was specified as Fe5.5- $s_{3p}2d_{2}f_{1}$, Si7.0- $s_{3p}3d_{2}$, where the number after each element stands for the radial cutoff in the unit of Bohr and the integer after s, p, d, and f indicates the radial multiplicity of each angular momentum component. The lattice constant was set to the experimental lattice constant of 5.65 Å. The cutoff energies for a charge density of 500 Ry and a k-point mesh of $36 \times 36 \times 36$ were used.

Figure 1(b) shows the magnetic field dependence of magnetization M at 300 K for Fe₃Si ferro-

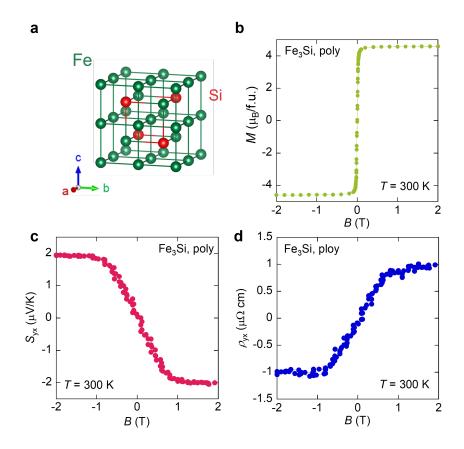


FIG. 1. (Color online) (a) The ordered cubic $D0_3$ structure for Fe₃Si (Space group: $Fm\bar{3}m$) (b)-(d) The magnetic field dependence of the magnetization M (b), the Nernst coefficient S_{yx} (c) and the Hall resistivity ρ_{yx} (d) for polycrystal Fe₃Si at 300 K.

magnet. The saturated magnetization M_s is around 4.6 $\mu_B/f.u$ at 300 K, which is comparable to the previous research ($M \sim 4.5 \mu_B/f.u$) [19]. As predicted by the Slater-Pauling rule, M_s for Fe₃Si is smaller than Fe₃Ga and Fe₃Al owing to the smaller number of valence electrons [7]. Figure 1 (c) and (d) show the *B* dependence of the Nernst coefficient S_{yx} and the Hall resistivity ρ_{yx} , respectively. Both S_{yx} and ρ_{yx} saturate at $B \sim 0.9$ T. The difference between the saturated magnetic field in magnetization (M) and transport properties (S_{yx} and ρ_{yx}) originates from the demagnetization effect owing to the shape anisotropy. S_{yx} reaches $\sim 2 \mu V/K$, which is nearly 10 times larger than that of pure iron [20]. This value is also comparable to the recent topological magnets such as kagome metal Fe₃Sn, Fe₃Sn₂ and TbMn₆Sn₆ [21–23], suggesting some topological feature in the band structure may also be important in Fe₃Si.

To understand the mechanism of the large S_{yx} in Fe₃Si, we also measure T dependence of both transverse and longitudinal electric (ρ_{yx} and ρ_{xx}) and thermoelectric properties (S_{yx} and S_{xx}) as shown in Fig. 2. On cooling, $-S_{yx}$ peaks at $T \sim 340$ K and then monotonically decreases down to the lowest temperature. $-S_{yx}$ becomes slightly negative below ~ 70 K due to the carrier type change. Similarly, Seebeck coefficient S_{xx} at zero fields also shows a peak around 340 K and monotonically decreases down to ~ 70 K accompanied by the sign change at ~ 160 K as shown in Fig.2 (c). The sign change of S_{xx} indicates the change of the dominant carrier type from the electron at high T to the hole low T.

On the other hand, ρ_{yx} monotonically decreases down to the lowest temperature (Fig.2 (b)). Although ρ_{yx} is governed by the AHE at high temperatures, clear *B*-linear ordinary Hall effect (OHE) contribution appears at low temperatures $T < \sim 100$ K and finally dominates at $T \sim 2$ K as shown in the inset of Fig.2 (b). As shown in Fig.2 (d), *T* dependence of ρ_{xx} exhibits a typical metallic behavior, monotonically decreasing on cooling to the lowest temperature. Although the residual resistivity ratio (RRR) is similar to Fe₃Ga single crystals, the absolute value of ρ_{xx} for Fe₃Si is only about 70% of that of Fe₃Ga [7].

To check the intrinsic contribution for ANE and AHE, we experimentally estimate the Hall conductivity σ_{yx} and transverse thermoelectric conductivity α_{yx} based on the following formulas,

$$\alpha_{yx} = \frac{1}{\rho_{xx}} [S_{yx} - \frac{\rho_{yx}}{\rho_{xx}} S_{xx}], \tag{1a}$$

$$\sigma_{yx} = -\rho_{yx}/\rho_{xx}^2. \tag{1b}$$

The obtained $-\sigma_{yx}$ and $-\alpha_{yx}$ are shown in Figs. 3 (a) and 3(b), respectively. Here, we only show the data above ~ 100 K since we cannot easily separate the ordinal Hall/Nernst contribution at low temperatures as discussed above. As shown in Fig. 3 (a), $-\sigma_{yx}$ shows a broad peak around 300 K and gradually decreases down to 100 K. On the other hand, $-\alpha_{yx}$ increases to 3 Am⁻¹K⁻¹ with a kink at $T \sim 340$ K and then monotonically decreases on cooling.

The equation (1a) can be rewritten as,

$$S_{yx} = \alpha_{yx}\rho_{xx} - \sigma_{yx}\rho_{xx}S_{xx} \equiv S_1 + S_2, \tag{2}$$

The second term could be also expressed as $S_2 = \tan(\theta_{AHE})S_{xx}$, where $\tan(\theta_{AHE})$ is anomalous Hall angle. The first term S_1 represents the transverse voltage directly driven by the transverse thermoelectric coefficient α_{yx} while the second term S_2 can be regarded as the Hall effect of the current flow generated by the Seebeck effect. As shown in Figure 3 (c), the contribution from S_2

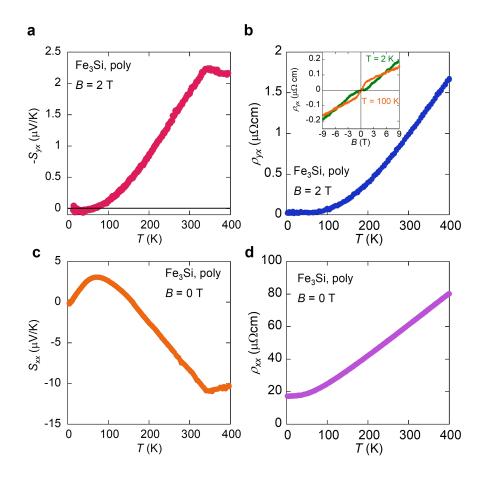


FIG. 2. (Color online) (a, b) The temperature T dependence of the Nernst coefficient $-S_{yx}$ (a) and Hall resistivity ρ_{yx} (b) under the magnetic field of 2 T. The inset of Figure 2 (b) is the field dependence of ρ_{yx} at 2 K and 100 K. (c, d) The temperature T dependence of the Seebeck coefficient S_{xx} (c) and longitudinal resistivity ρ_{xx} (d) under zero magnetic field.

is almost negligible around room temperature (~10% of S_1). This indicates that the origin of the large ANE at room T is indeed the large α_{yx} .

In fact, the room temperature $|\alpha_{yx}|$ for Fe₃Si is even larger than that for some topological materials with large ANE, such as Co₂MnGa $[|\alpha_{yx}| \sim 2.7 \text{ Am}^{-1}\text{K}^{-1}]$ and Fe₃Sn $[|\alpha_{yx}| \sim 2.3 \text{ Am}^{-1}\text{K}^{-1}]$ [8, 22]. However, the experimental S_{yx} for Fe₃Si at 300 K is much smaller than Co₂MnGa $[S_{yx} \sim 6.5 \mu \text{V/K}]$. According to equation (2), this difference can be explained by two reasons. Firstly, the ρ_{xx} for Fe₃Si is smaller than those topological semimetals [7, 8, 22]. The Nernst voltage is the combination of the current flow induced by spin-orbital coupling (SOC) and

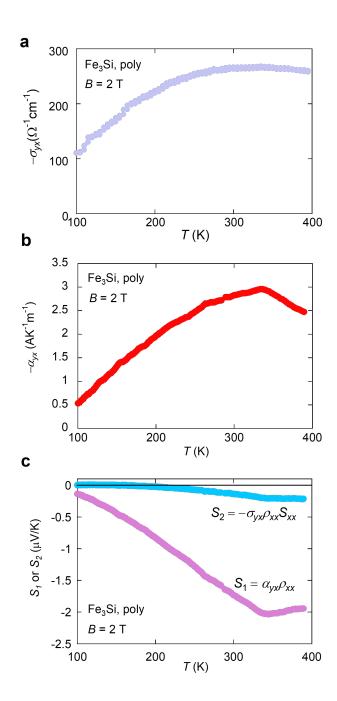


FIG. 3. (Color online) The temperature T dependence of the Hall conductivity $-\sigma_{yx}$ (a), the transverse thermoelectric conductivity $-\alpha_{yx}$ (b), and two contributions S_1 and S_2 to anomalous Nernst effect (c) under the magnetic field of 2 T.

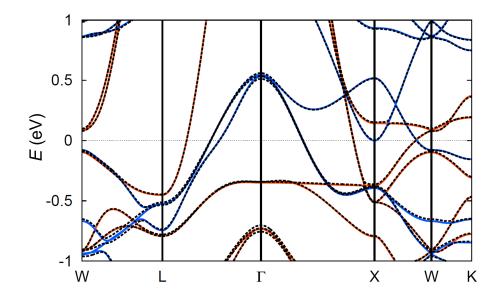


FIG. 4. (Color online) Band structure around the Fermi energy for Fe₃Si obtained from first-principles calculations for the case of magnetization $M = 5.1 \ \mu_B/f.u.$ along [001]. The red and blue lines represent the majority and minority bands without SOC, respectively. The black dotted line corresponds to the bands with SOC.

the material resistance. Thus, the larger the longitudinal resistivity is, the larger ANE becomes if $|\alpha_{yx}|$ is the same. However, We note that the large resistivity suppresses the magnitude of the figure of merit $ZT = \sigma S^2 T/\kappa$, power factor $PF = \sigma S^2$ and the specific power generation capacity $\Gamma_{\rm P} = P_{\rm max}/(A(\Delta T)^2)$ in thermoelectric devices. Therefore, semimetals with a resistivity of 100 ~ 200 $\mu\Omega$ cm at room temperature are more suitable for practical applications. Secondly, the second term S_2 doesn't contribute too much to the total S_{yx} in Fe₃Si. In Co₂MnGa, this contribution accounts for roughly 50 % of the total S_{yx} because of the large Hall angle tan (θ_{AHE}) [8]. This phenomenon is also found in Co₃Sn₂S₂ [9, 24]. In order to utilize S_2 to improve the total S_{yx} , the tan(θ_{AHE}) should be large ~ 0.1, which is often discovered in topological ferromagnets with Weyl points [25, 26].

Figure 4 shows the band structure around the Fermi energy for Fe₃Si obtained from firstprinciples calculation. Around the L point, nodal web structures similar to Fe₃Ga, composed of minority bands [27], are found around $E = E_F - 0.6$ eV. Unlike Fe₃Ga, the distance of the nodal web from E_F is far to affect the transport properties. It indicates the origin of the large ANE for Fe₃Si might be different. In fact, we also found a flat band-like structure on the Γ -X line. Since topological flat band structures could also be the source of giant ANE and AHE [28, 29], a further theoretical investigation is required to reveal the origin of the large transverse thermoelectric coefficient.

III. CONCLUSIONS

We have discovered a large ANE in the polycrystalline Fe₃Si, the sister compound of Fe₃Ga and Fe₃Al. The one-step synthesis method and the low material cost make it the most promising material in the Fe₃X system for future applications. In addition, for thin film applications, Fe₃Si could have better compatibility with other silicon-based electronic devices [30]. The electronic band structure for Fe₃Si indicates that the dispersion-less band on the Γ -X line might induce a large Berry curvature instead of the nodal web structure like Fe₃Ga. However, the topological electronic structure as an origin of large ANE in Fe₃Si is still an open question. For this purpose, systematic research based on single-crystal Fe₃Si is also expected in the future.

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